

The CL - 209 is a high - power GaAlAs IRED mounted in a TO - 46 metal stem with clear epoxy encapsulation, providing wide beam angle.

### FEATURES

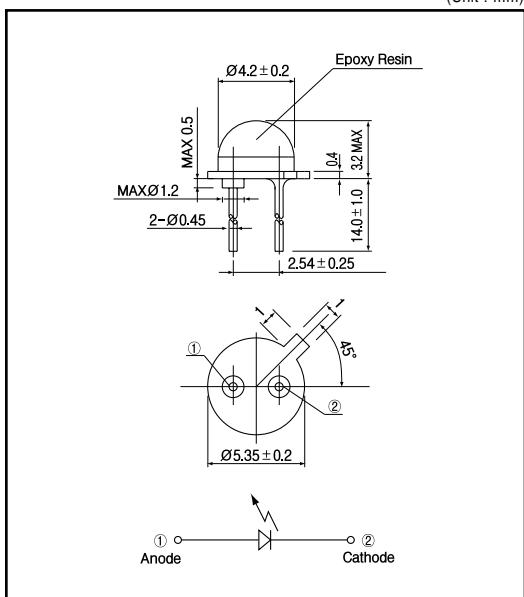
- High output power
- Wide beam angle  $\pm 85\text{deg}$ .
- TO - 46 epoxy potting type

### APPLICATIONS

- Optical switches
- Transportation sensors

### DIMENSIONS

(Unit : mm)



### MAXIMUM RATINGS

(Ta=25 )

Item	Symbol	Rating	Unit
Reverse voltage	V <sub>R</sub>	5	V
Forward current	I <sub>F</sub>	80	mA
Power dissipation	P <sub>D</sub>	130	mW
Pulse forward current <sup>①</sup>	I <sub>FP</sub>	0.8	A
Operating temp.	T <sub>opr.</sub>	- 20 + 80	
Storage temp.	T <sub>stg.</sub>	- 20 + 80	
Soldering temp. <sup>②</sup>	T <sub>sol.</sub>	240	

<sup>①</sup>1. pulse width : tw 100  $\mu$ sec, period : T=10msec.

<sup>②</sup>2. For MAX.5 seconds at the position of 2 mm from the package

### ELECTRO-OPTICAL CHARACTERISTICS

(Ta=25 )

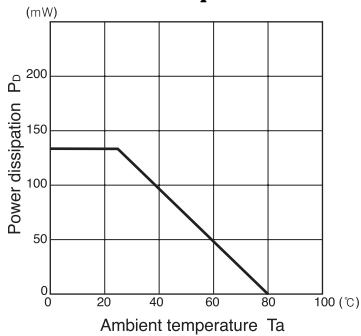
Item	Symbol	Conditions	Min.	Typ.	Max.	Unit.
Forward voltage	V <sub>F</sub>	I <sub>F</sub> =20mA		1.3	1.6	V
Reverse current	I <sub>R</sub>	V <sub>R</sub> =5V			10	μA
Peak emission wavelength <sup>③</sup>	λ <sub>p</sub>	I <sub>F</sub> =50mA		880		nm
Spectral bandwidth		I <sub>F</sub> =50mA		70		nm
Radiant intensity	P <sub>O</sub>	I <sub>F</sub> =20mA		30		mV
Half angle				± 85		deg.

<sup>③</sup>3. Measured by tester of KODENSHI CORP.

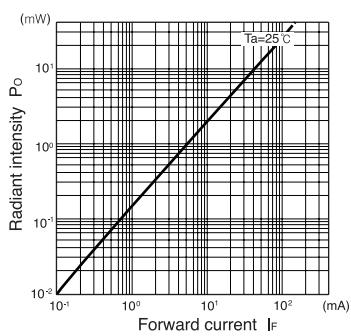
# Infrared Emitting Diodes(GaAlAs)

CL - 209

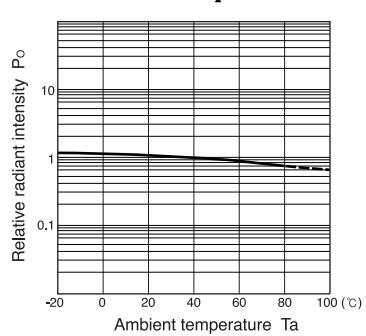
**Power dissipation Vs.  
Ambient temperature**



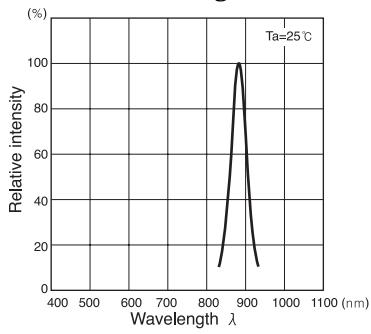
**Radiant intensity Vs.  
Forward current**



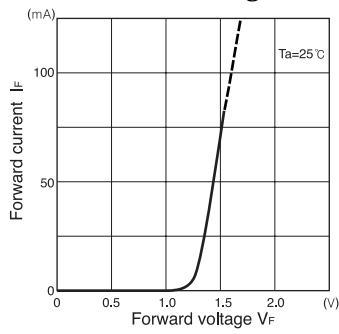
**Relative radiant intensity Vs.  
Ambient temperature**



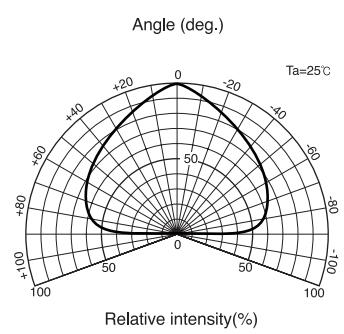
**Relative intensity Vs.  
Wavelength**



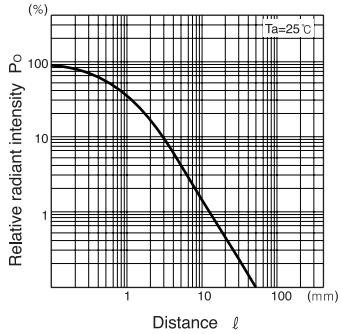
**Forward current Vs.  
Forward voltage**



**Radiant Pattern**



**Relative radiant intensity Vs.  
Distance**



Relative radiant intensity Vs.  
Distance test method

